

## Opus evaluation and profiling software expansion for STM32Cube

Application	X-CUBE-OPUS	
Middleware	STCmdP	Opus
Hardware Abstraction	STM32Cube Hardware Abstraction Layer (HAL)	
Hardware	STM32WB Nucleo pack P-NUCLEO-WB55	
	STM32 Nucleo development board	



### Features

- Complete tool to evaluate and profile the advanced Opus audio codec with each possible configuration on different STM32 MCU families (ARM Cortex-M4, M7, M33)
- Firmware example that shows how to use and integrate Opus on different STM32 MCU families
- Sample application (compatible with Python 3.7) that allows to configure Opus, send audio data to [STM32 Nucleo](#) development boards and receive profiling results
- Third-party Opus v1.3.1 (downloadable from <https://www.opus-codec.org>): an open, royalty-free and highly versatile audio codec that is standardized by the Internet Engineering Task Force (IETF) as [RFC 6716](#)
- Custom serial protocol to allow easy communication between the [STM32 Nucleo](#) development board and the Host using dedicated commands
- Sample implementation available on [NUCLEO-F413ZH](#), [NUCLEO-H743ZI](#), [NUCLEO-F746ZG](#), [NUCLEO-L552ZE-Q](#) or [P-NUCLEO-WB55](#) development boards
- Easy portability across different MCU families, thanks to [STM32Cube](#)
- Free, user-friendly license terms

### Description

The [X-CUBE-OPUS](#) expansion software package for [STM32Cube](#) runs on different STM32 MCU families and includes a firmware example that allows to easily configure and profile Opus encoder and decoder.

The expansion is built on [STM32Cube](#) software technology to ease portability across different STM32 microcontrollers.

The software comes with a sample implementation of the drivers running on [NUCLEO-F413ZH](#), [NUCLEO-H743ZI](#), [NUCLEO-F746ZG](#), [NUCLEO-L552ZE-Q](#) or [P-NUCLEO-WB55](#) development boards.

The package provides a Python application to be used together with the STM32 example to create a point-to-point bidirectional communication. The software allows the user to choose Opus settings, via an intuitive GUI, select different audio input files for profiling test and receive back results as well as encode/decode data.

The two nodes (the host with Python app and the STM32) communicate through the ST-Link Virtual COM port with a custom protocol.

The [X-CUBE-OPUS](#) expansion software package allows the user to evaluate Opus performance depending on his target application, facilitating the choice of the correct STM32 and easily integrating the audio codec.

Product summary	
Opus evaluation and profiling software expansion for STM32Cube	<a href="#">X-CUBE-OPUS</a>
Bluetooth 5 and 802.15.4 Nucleo pack including USB dongle and Nucleo-68 with STM32WB55 MCUs	<a href="#">P-NUCLEO-WB55</a>
STM32 Nucleo-144 development board with STM32F413ZH/ STM32H743ZI/ STM32F746ZG/ STM32-L552ZE MCUs	<a href="#">NUCLEO-F413ZH</a> / <a href="#">NUCLEO-H743ZI</a> / <a href="#">NUCLEO-F746ZG</a> / <a href="#">NUCLEO-L552ZE-Q</a>
Applications	<a href="#">Wireless Connectivity</a>

## 1 Detailed description

### 1.1 What is STM32Cube?

**STM32Cube** is a combination of a full set of PC software tools and embedded software blocks running on STM32 microcontrollers and microprocessors:

- **STM32CubeMX** configuration tool for any STM32 device; it generates initialization C code for Cortex-M cores and the Linux device tree source for Cortex-A cores
- **STM32CubeIDE** integrated development environment based on open-source solutions like Eclipse or the GNU C/C++ toolchain, including compilation reporting features and advanced debug features
- **STM32CubeProgrammer** programming tool that provides an easy-to-use and efficient environment for reading, writing and verifying devices and external memories via a wide variety of available communication media (JTAG, SWD, UART, USB DFU, I2C, SPI, CAN, etc.)
- **STM32CubeMonitor** family of tools (**STM32CubeMonRF**, **STM32CubeMonUCPD**, **STM32CubeMonPwr**) to help developers customize their applications in real-time
- **STM32Cube MCU and MPU packages** specific to each STM32 series with drivers (HAL, low-layer, etc.), middleware, and lots of example code used in a wide variety of real-world use cases
- **STM32Cube expansion packages** for application-oriented solutions

### 1.2 How does this software complement STM32Cube?

The proposed software is based on the STM32CubeHAL, the hardware abstraction layer for the STM32 microcontroller. The package extends **STM32Cube** by providing a Board Support Package (BSP) for each **STM32 Nucleo** development board supported, an ST middleware that implements a serial communication protocol and the third-party middleware Opus for audio encoding and decoding.

The drivers abstract low-level details of the hardware and allow applications to access the communication channel in a hardware independent fashion.

The package also includes a sample Python application that the user should use together with the STM32 example to evaluate Opus resources demand and performance. The software allows to select all the different Opus configuration settings, choose an input audio file to be encoded and decoded, obtain profiling results shown in an intuitive plot or saved in a detailed log file.

The **X-CUBE-OPUS** expansion software package offers, together with the profiling tool, an easy to use interface that facilitates the integration of Opus audio codec into other firmware for any STM32.

## Revision history

**Table 1. Document revision history**

Date	Version	Changes
18-Nov-2020	1	Initial release.

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